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SE30AFB, SE30AFD, SE30AFG, SE30AFJ

Vishay General Semiconductor

Surface Mount ESD Capability Rectifiers



ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS | | | | |
|--|----------------------------|--|--|--|
| I _{F(AV)} | 3.0 A | | | |
| V _{RRM} | 100 V, 200 V, 400 V, 600 V | | | |
| I _{FSM} | 40 A | | | |
| V_F at I_F = 3.0 A (T_A = 125 °C) | 0.86 V | | | |
| I _R | 10 µA | | | |
| T _J max. | 175 °C | | | |
| Package | SlimSMA (DO-221AC) | | | |
| Circuit configuration | Single | | | |

FEATURES

- Very low profile typical height of 0.95 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop, low leakage current
- · ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both consumer and automotive applications.

MECHANICAL DATA

Case: SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

| MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted) | | | | | | |
|--|-----------------------------------|---------------|---------|---------|---------|------|
| PARAMETER | SYMBOL | SE30AFB | SE30AFD | SE30AFG | SE30AFJ | UNIT |
| Device marking code | | S3B | S3D | S3G | S3J | |
| Maximum repetitive peak reverse voltage | V _{RRM} | 100 | 200 | 400 | 600 | V |
| Maximum DC forward current | I _F ⁽¹⁾ | 3.0 | | | | А |
| | I _F ⁽²⁾ | | | | | |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | I _{FSM} | 40 | | | | А |
| Operating junction and storage temperature range | T _J , T _{STG} | G -55 to +175 | | | | °C |

Notes

⁽¹⁾ Mounted on 15 mm x 15 mm pad areas, 2 oz. FR4 PCB

⁽²⁾ Free air, mounted on recommended copper pad area

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HALOGEN

FREE



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| ELECTRICAL CHARACTERISTICS ($T_A = 25$ °C unless otherwise noted) | | | | | | |
|---|--|---------------------------|---------------------------------|------|------|------|
| PARAMETER | TEST C | ONDITIONS | SYMBOL | TYP. | MAX. | UNIT |
| Instantaneous forward voltage | I _F = 1.5 A | T _A = 25 °C | V _F ⁽¹⁾ | 0.91 | - | V |
| | I _F = 3.0 A | | | 0.97 | 1.1 | |
| | I _F = 1.5 A | – T _A = 125 °C | | 0.79 | - | |
| | I _F = 3.0 A | | | 0.86 | 0.98 | |
| Reverse current | Datad \/ | T _A = 25 °C | - I _R ⁽²⁾ | - | 10 | μA |
| | Rated V _R | T _A = 125 °C | | 13 | 100 | |
| Typical reverse recovery time | I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A | | t _{rr} | 1.5 | - | μs |
| Typical junction capacitance | 4.0 V, 1 MHz | | CJ | 19 | - | pF |

Notes

⁽¹⁾ Pulse test: 300 µs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 40 ms

| THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted) | | | | | | | |
|--|---------------------------------|---------|---------|---------|---------|------|--|
| PARAMETER | SYMBOL | SE30AFB | SE30AFD | SE30AFG | SE30AFJ | UNIT | |
| Typical thermal resistance | R _{0JA} ⁽¹⁾ | 125 | | | | °C/W | |
| | R _{0JM} ⁽²⁾ | 12 | | | | 0/10 | |

Notes

 $^{(1)}$ Free air, mounted on recommended PCB, 1 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

 $^{(2)}$ Mounted on 15 mm x 15 mm pad areas, 2 oz. FR4 PCB; $R_{\theta JM}$ - junction to mount

| IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25$ °C unless otherwise noted) | | | | | | |
|---|---------------------------------|--------------------------------|----------------|-------|--------|--|
| STANDARD | TEST TYPE | TEST CONDITIONS | SYMBOL | CLASS | VALUE | |
| AEC-Q101-001 | Human body model (contact mode) | C = 100 pF, R = 1.5 k Ω | V _C | H3B | > 8 kV | |

| ORDERING INFORMATION (Example) | | | | | |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | |
| SE30AFJ-M3/6A | 0.032 | 6A | 3500 | 7" diameter plastic tape and reel | |
| SE30AFJ-M3/6B | 0.032 | 6B | 14 000 | 13" diameter plastic tape and reel | |
| SE30AFJHM3/6A ⁽¹⁾ | 0.032 | 6A | 3500 | 7" diameter plastic tape and reel | |
| SE30AFJHM3/6B ⁽¹⁾ | 0.032 | 6B | 14 000 | 13" diameter plastic tape and reel | |

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

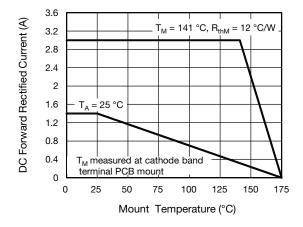


Fig. 1 - Maximum Forward Current Derating Curve

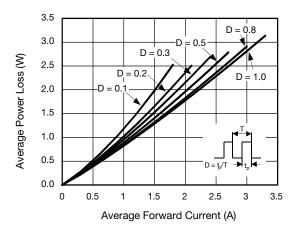


Fig. 2 - Forward Power Loss Characteristics

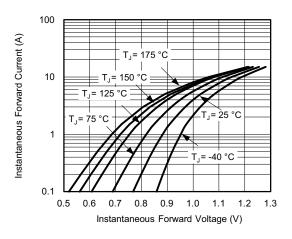


Fig. 3 - Typical Instantaneous Forward Characteristics

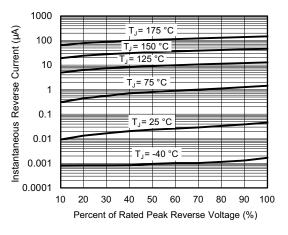


Fig. 4 - Typical Reverse Leakage Characteristics

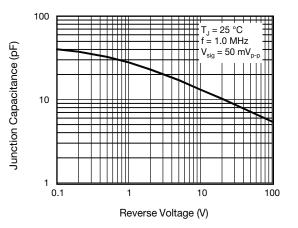


Fig. 5 - Typical Junction Capacitance

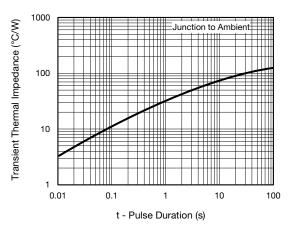
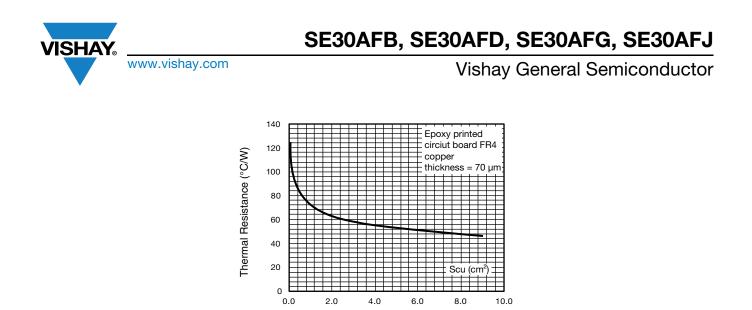


Fig. 6 - Transient Thermal Impedance

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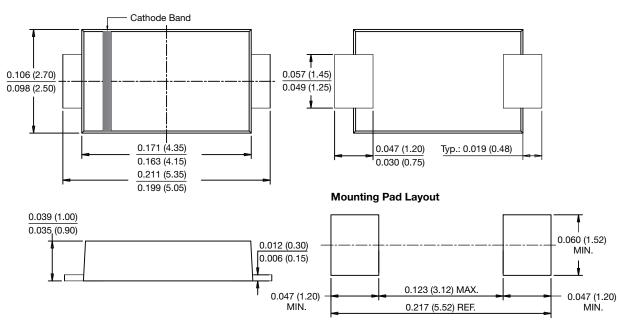
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Copper Pad Areas (cm²)

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



SlimSMA (DO-221AC)



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